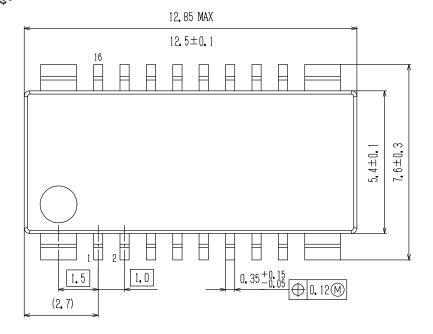
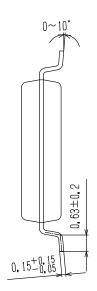
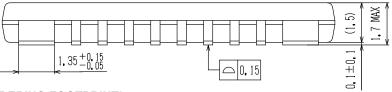
SOIC16-TL / MFP16FS (300 mil) CASE 751CD ISSUE A

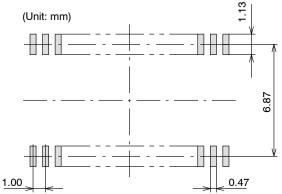
DATE 08 NOV 2013

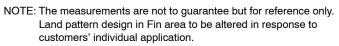






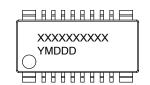
SOLDERING FOOTPRINT*





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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DESCRIPTION:	SOIC16-TL / MFP16FS (300 MIL)		PAGE 1 OF 1

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